

MMBD4448

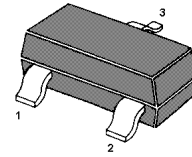
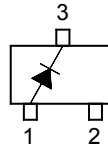
Silicon Epitaxial Planar Switching Diode

Features

- Fast switching speed
- High Conductance

Applications

- For general purpose switching



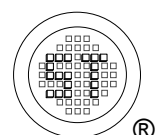
Marking Code: **5D**
TO-236 Plastic Package

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	100	V
Reverse Voltage	V_R	75	V
Average Rectified Forward Current	$I_{F(AV)}$	250	mA
Forward Continuous Current	I_{FM}	500	mA
Non-repetitive Peak Forward Surge Current	I_{FSM}	2	A
at $t = 1$ s at $t = 1$ μ s		4	
Power Dissipation	P_d	350	mW
Junction and Storage Temperature Range	T_j, T_{stg}	- 65 to + 150	$^\circ\text{C}$

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F = 5$ mA at $I_F = 10$ mA at $I_F = 100$ mA at $I_F = 150$ mA	V_F	0.62	0.72	V
		-	0.855	
		-	1	
		-	1.25	
Reverse Current at $V_R = 20$ V at $V_R = 75$ V at $V_R = 25$ V, $T_j = 150^\circ\text{C}$ at $V_R = 75$ V, $T_j = 150^\circ\text{C}$	I_R	-	25	nA
		-	2.5	μA
		-	30	μA
		-	50	μA
Junction Capacitance at $V_R = 0$ V, $f = 1$ MHz	C_j	-	4	pF
Reverse Recovery Time at $I_F = I_R = 10$ mA, $I_{rr} = 0.1 \times I_R$, $R_L = 100 \Omega$	t_{rr}	-	4	ns



Dated : 15/06/2009

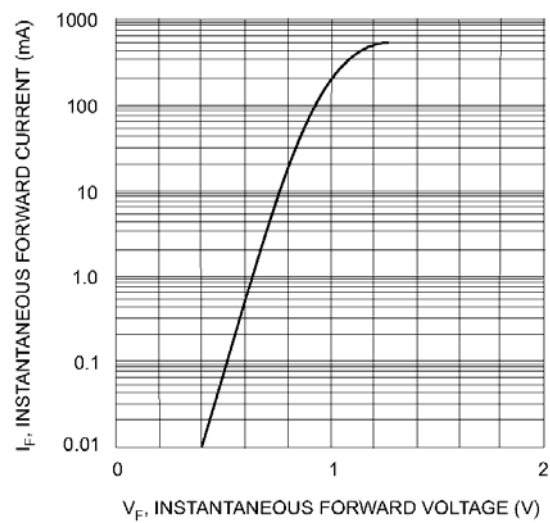


Fig. 1 Forward Characteristics

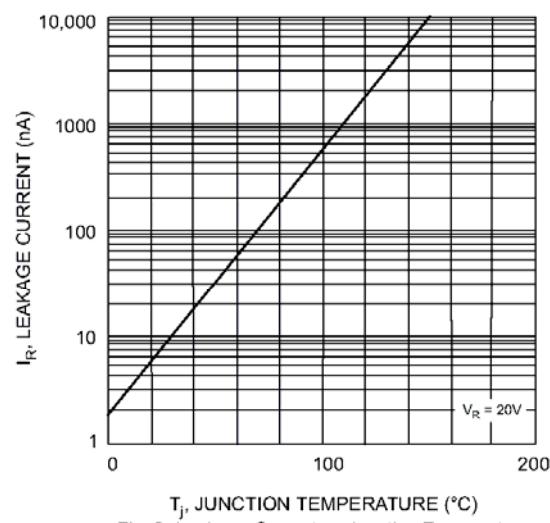


Fig. 2 Leakage Current vs Junction Temperature

